

Inductors for power circuits

Size 3.2 x 2.5 x 2.5 (mm)

Series/Type: CLT32

Date: December 2024

Inductors for power circuits

CLT32

Size 3.2 x 2.5 x 2.5 (mm)

Size 1210 (EIA)

Rated inductance 17... 440 nH

Typical saturation current 13.5...60 A

Construction

- Thick copper frame
- Molded metal solution
- No internal connection

Features

- High current, low DC resistance
- Temperature range from $-40\text{ }^{\circ}\text{C}$ up to $+165\text{ }^{\circ}\text{C}$ incl. self-heating
- ESD tested up to 2 kV to AEC-Q200
- Suitable for lead-free reflow soldering as referenced in JEDEC J-STD 020D
- Qualified to AEC-Q200
- RoHS-compatible

Applications

- PMIC systems in automotive electronics

Terminals

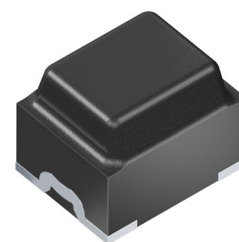
- Tinned terminals
- Layer composition Ni, Sn
- Lead-free tinned

Marking

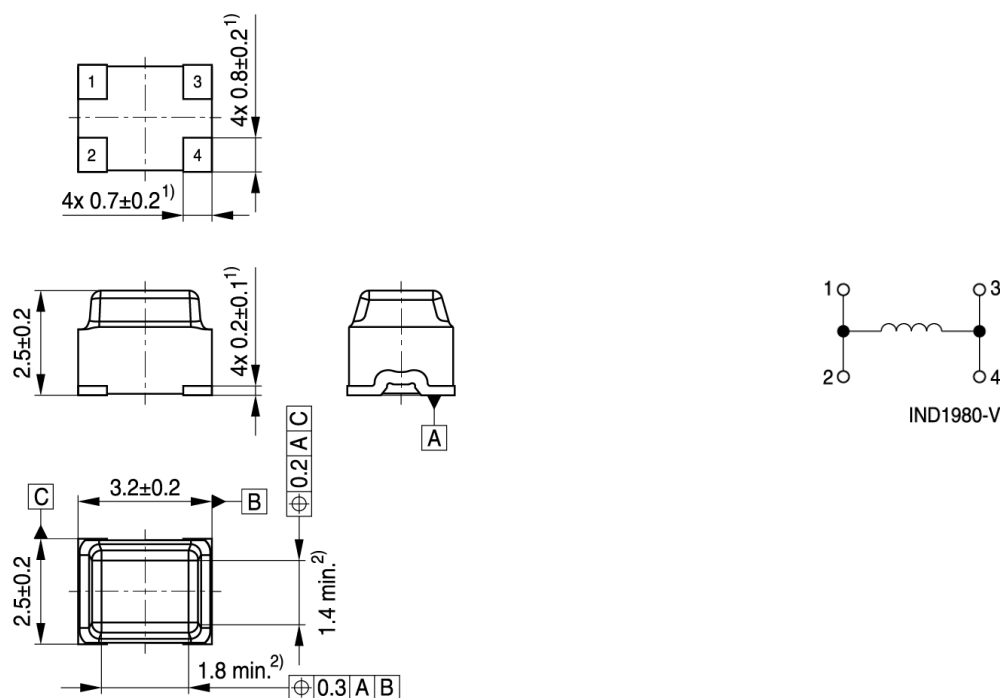
- No marking on component
- Minimum data on reel:
Manufacturer, ordering code, lot number, quantity, date of packing

Delivery mode and packing unit

- 12-mm blister tape, wound on 330-mm \varnothing reel
- Packing unit: 6000 pcs./reel



Dimensions



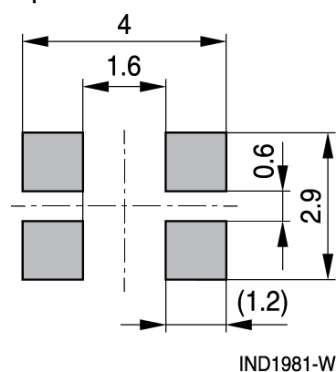
¹⁾ Soldering area

²⁾ Suction area

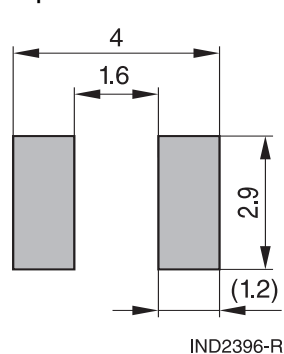
IND1762-T-E

Layout recommendation

Option 1

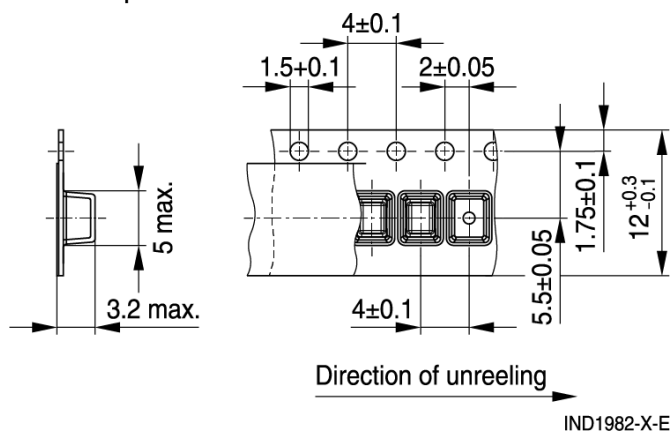


Option 2

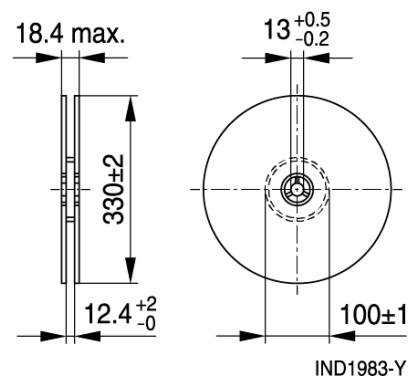


Taping and packing

Blister tape



Reel



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Technical data and measuring conditions

Rated inductance L_R	Measured with Agilent 4990A at 1 MHz, 0.1 V, +23 °C \pm 3 °C
Inductance tolerance	\pm 20% at +23 °C \pm 3 °C
Operating temperature range	–40 °C ... +165 °C
Rated current I_{temp}	Based on the temperature increase (temperature increase 40 K by self-heating) Ambient temperature: +23 °C Measured in 100 μ m Cu thickness single layer PCB 100x40x1 mm (equivalent to multilayer PCB) Temperature rise is highly dependent on many factors and consequently, it must be verified in final application
Saturation current I_{sat}	Based on the inductance change rate (30% below the initial value)
DC resistance R_{DC}	Measured at +23 °C \pm 3 °C; tolerance \pm 15%
Solderability (lead-free)	Sn95.5Ag3.8Cu0.7: +245 °C / 5 s Method: Solder bath (Dip) Wetting of soldering area: \geq 95%
Resistance to soldering heat	+260 °C, 40 s (as referenced in JEDEC J-STD 020D)
Climatic category	40/165/56 (to IEC 60068-1)
Storage conditions	Mounted: –40 °C ... +165 °C Packaged: –25 °C ... +40 °C, \leq 75% RH
Weight	Approx. 120 mg

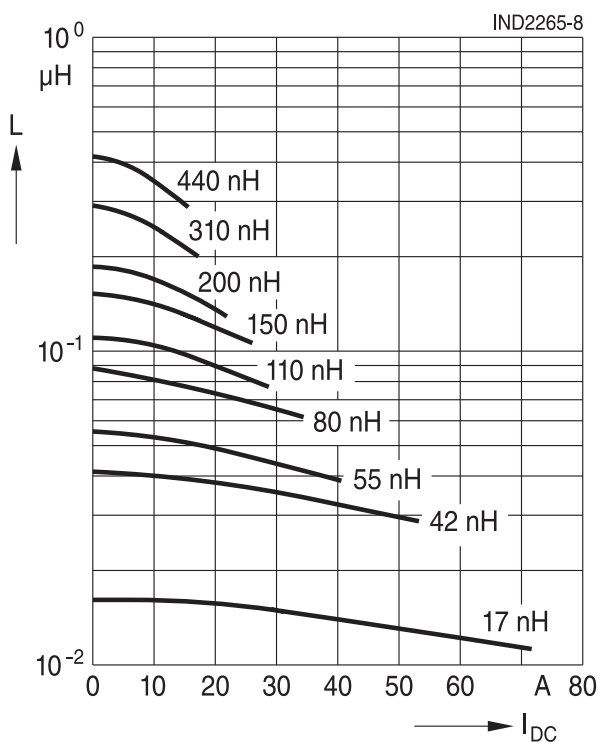
Characteristics and ordering codes

L_R	$R_{DC,typ}$	$I_{Sat,typ}$ at 23 °C	$I_{temp,typ}$ at 23 °C at +40 K temp. increase	Internal code	Ordering code
nH	m Ω	A	A		
17	0.39	60.0	45.0	B82403T0170M000	CLT32-17N
42	1.0	54.0	28.0	B82403T0420M000	CLT32-42N
55	1.0	39.5	28.0	B82403T0550M000	CLT32-55N
80	1.9	36.0	20.0	B82403T0800M000	CLT32-80N
110	1.9	29.0	20.0	B82403T0111M000	CLT32-R11
150	3.3	25.4	15.4	B82403T0151M000	CLT32-R15
200	3.3	20.5	15.4	B82403T0201M000	CLT32-R20
310	5.3	17.5	12.1	B82403T0311M000	CLT32-R31
440	7.6	13.5	10.1	B82403T0441M000	CLT32-R44

Inductance L versus DC load current I_{DC}

Measured with magnetics analyzer Wayne Kerr 3260B

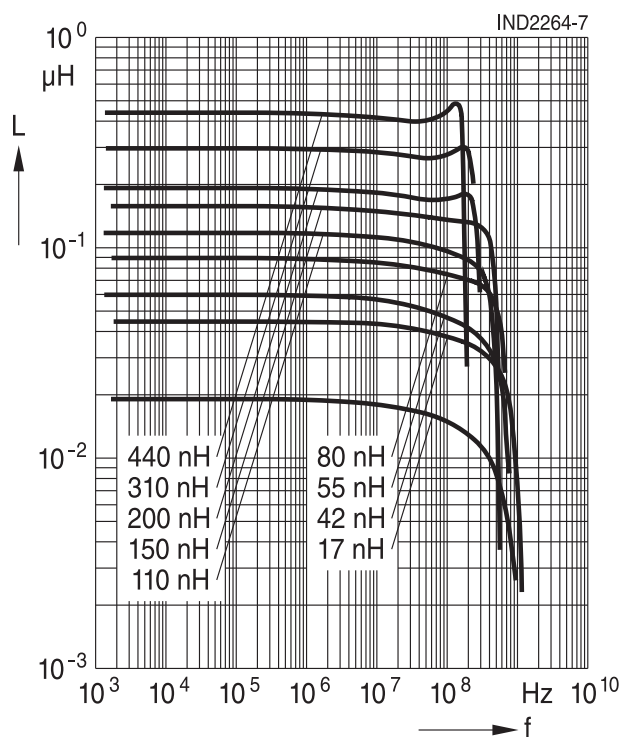
Typical values at +23 \pm 3 $^{\circ}$ C



Inductance L versus frequency f

Measured with impedance analyzer Keysight E4990A

Typical values at +23 \pm 3 $^{\circ}$ C



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Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition), online catalogs and in the data sheets.
 - Particular attention should be paid to the derating curves, if given. Derating applies in the case the ambient temperature in application exceeds the rated temperature of the component.
 - Ensure the operation temperature of the component in application not to exceed the maximum specified value or the upper climatic category temperature.
 - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. It is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.

Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g., ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.
- The following points must be observed if the components are potted, sealed, or varnished in customer applications:
 - Many potting, sealing, or varnishing materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
 - It is necessary to check whether the potting, sealing or varnishing materials used attack or destroy the wire insulation, plastics, or glue.
 - The effect of the potting, sealing, or varnishing materials may change the high-frequency behavior of the components.
 - Many coating materials have a negative effect (chemically and mechanically) on the winding wires, insulation materials and connecting points. Customers are always obligated to determine whether and to what extent their coating materials influence the component.

Customers are responsible and bear all risk for the use of the coating material. TDK Electronics does not assume any liability for failures of our components that are caused by the coating material.
- Magnetic core materials such as ferrites are sensitive to direct impact. This can cause the core material to flake or lead to breakage of the magnetic core material.
- Any type of tension or pressure on the product may result in damage and affect its functionality and reliability.
 - The products are only to be attached to fixings or mounting holes provided for this purpose in accordance with the data sheet.
 - If additional mechanical forces are applied to the component, e.g., application of gap pads, it is necessary to check whether they attack or destroy any part of the component.
 - It is not permitted for the product specified in the data sheet to assume a mechanical function in the final application.
- Inductance value can drop if external metallic or magnetic parts will be put close to the coil or into the air gap of the coil or core or magnetic material.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.
- Due to product design and applied manufacturing process, appearance, symmetry, and shape of not dimensioned details could vary within same lot, as well discoloration of housing is possible. TDK does not expect detrimental effects on product function or reliability. In case of conflicts, TDK reference standard shall prevail.

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Cautions and warnings

Display of ordering codes for TDK Electronics products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications, on the company website, or in order-related documents such as shipping notes, order confirmations and product labels. **The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products.** Detailed information can be found on the Internet under www.tdk-electronics.tdk.com/orderingcodes.

Important notes

The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application**. As a rule we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.
2. We also point out that **in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified**. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
3. **The warnings, cautions and product-specific notes must be observed.**
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6. Unless otherwise agreed in individual contracts, **all orders are subject to our General Terms and Conditions of Supply**.

Important notes

7. **Our manufacturing sites serving the automotive business apply the IATF 16949 standard.**
The IATF certifications confirm our compliance with requirements regarding the quality management system in the automotive industry. Referring to customer requirements and customer specific requirements ("CSR") TDK always has and will continue to have the policy of respecting individual agreements. Even if IATF 16949 may appear to support the acceptance of unilateral requirements, we hereby like to emphasize that **only requirements mutually agreed upon can and will be implemented in our Quality Management System**. For clarification purposes we like to point out that obligations from IATF 16949 shall only become legally binding if individually agreed upon.
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